

## PSC Assignment 6

Q1 Consider the following parameters in a silicon pn junction:

$$\begin{array}{ll} N_a = N_d = 10^{16} \text{ cm}^{-3} & n_i = 1.5 \times 10^{10} \text{ cm}^{-3} \\ D_n = 25 \text{ cm}^2/\text{s} & \tau_{p0} = \tau_{n0} = 5 \times 10^{-7} \text{ s} \\ D_p = 10 \text{ cm}^2/\text{s} & \epsilon_r = 11.7 \end{array}$$

- (a) Determine the ideal reverse-saturation current density  $J_s$  at  $T = 300 \text{ K}$ .  
 (b) Design the diode such that electron and hole current densities  $J_n = 20 \text{ A/cm}^2$  and  $J_p = 5 \text{ A/cm}^2$  at  $V_a = 0.65 \text{ V}$ .

Ans (a)  $J_s = 4.16 \times 10^{-11} \text{ A/cm}^2$

(b)  $N_a = 1.0 \times 10^{15} \text{ /cm}^3$ ,  $N_d = 2.5 \times 10^{15} \text{ /cm}^3$

Q2 Consider a silicon pn junction initially biased at  $0.60 \text{ V}$  at  $T = 300 \text{ K}$ . Assume the temperature increases to  $T = 310 \text{ K}$ . Calculate the change in the forward-bias voltage required to maintain a constant current through the junction.

Ans  $V = 0.583 \text{ V}$

Q3 A silicon pn junction at  $T = 300 \text{ K}$  has the following parameters:  $N_a = 5 \times 10^{16} \text{ cm}^{-3}$ ,  $N_d = 1 \times 10^{16} \text{ cm}^{-3}$ ,  $D_n = 25 \text{ cm}^2/\text{s}$ ,  $D_p = 10 \text{ cm}^2/\text{s}$ ,  $\tau_{n0} = 5 \times 10^{-7} \text{ s}$ , and  $\tau_{p0} = 1 \times 10^{-7} \text{ s}$ . The cross-sectional area is  $A = 10^{-3} \text{ cm}^2$  and the forward-bias voltage is  $V_a = 0.625 \text{ V}$ . Calculate the (a) minority electron diffusion current at the space charge edge, (b) minority hole diffusion current at the space charge edge, and (c) total current in the pn junction diode.

Ans (a)  $0.154 \text{ mA}$  (b)  $1.09 \text{ mA}$  (c)  $1.24 \text{ mA}$

Q4 Consider an ideal silicon pn junction diode. (a) What must be the ratio of  $N_d/N_a$  so that 90 percent of the current in the depletion region is due to the flow of electrons? (b) Repeat part (a) if 80 percent of the current in the depletion region is due to the flow of holes.

Ans (a)  $N_d/N_a = 12.7$  (b)  $N_a/N_d = 2.8$

Q5 A silicon pn junction with a cross-sectional area of  $10^{-4} \text{ cm}^2$  has the following properties at  $T = 300 \text{ K}$ :

n region	p region
$N_d = 10^{17} \text{ cm}^{-3}$	$N_a = 5 \times 10^{15} \text{ cm}^{-3}$
$\tau_{p0} = 10^{-7} \text{ s}$	$\tau_{n0} = 10^{-6} \text{ s}$
$\mu_n = 850 \text{ cm}^2/\text{V-s}$	$\mu_n = 1250 \text{ cm}^2/\text{V-s}$
$\mu_p = 320 \text{ cm}^2/\text{V-s}$	$\mu_p = 420 \text{ cm}^2/\text{V-s}$

- (a) Sketch the thermal equilibrium energy-band diagram of the pn junction, including the values of the Fermi level with respect to the intrinsic level on each side of the junction. (b) Calculate the reverse-saturation current  $I_s$  and determine the forward-bias current  $I$  at a forward-bias voltage of  $0.5 \text{ V}$ . (c) Determine the ratio of hole current to total current at the space charge edge  $x_n$ .

Ans (a)  $I_s = 4.4 \times 10^{-15} \text{ A}$ ,  $1 \times 10^{-6} \text{ A}$ , (c)  $0.074$

